

### DEPARTMENT OF MECHANICAL ENGINEERING

# COURSE STRUCTURE & SYLLABUS M.Tech ME for COMPUTER AIDED DESIGN & MANUFACTURING PROGRAMME

(Applicable for batches admitted from 2019-2020)



JAWAHARLAL NEHRU TECHNOLOGICAL UNIVERSITY KAKINADA



I Semester						
S.No	Course Code	Course Name	L	T	P	Credits
1	CD 101	Geometric Modeling	3	0	0	3
2	CD 102	Computer Aided Manufacturing	3	0	0	3
3	CD 103	Program Elective – 1	3	0	0	3
	CD 1031	Computational Methods in Engineering				
	CD 1032	Materials Technology				
	CD 1033	Mechanical Vibrations				
4	CD 104	Program Elective – 2	3	0	0	3
	CD 1041	Mechatronics				
	CD 1042	Industrial Robotics				
	CD 1043	Simulation of Manufacturing Systems				
5	CD 105	Advanced CAD Lab	0	0	4	2
6	CD 106	Advanced manufacturing Lab	0	0	4	2
7	CD 107	Research Methodology and IPR	2	0	0	2
8	CD 108	Writing Skills for Scientific Communication	2	0	0	0
Total						

II Semes	ter					
S.No	Course Code	Course Name	L	T	P	Credits
1	CD 201	Theory of Elasticity and Plasticity	3	0	0	3
2	CD 202	Advanced Manufacturing Processes	3	0	0	3
3	CD 203	Program Elective – 3	3	0	0	3
	CD 2031	Advanced Finite Element Methods				
	CD 2032	Fracture mechanics				
	CD 2033	Product Design and Development				
4	CA 204	Program Elective – 4	3	0	0	3
	CD 2041	Materials Characterization Techniques				
	CD 2042	Optimization & Reliability				
	CD 2043	Additive Manufacturing				
5	CD 205	Material Characterization Lab	0	0	4	2
6	CD 206	Simulation of Manufacturing Systems Lab	0	0	4	2
7	CD 207	Mini Project With Seminar	2	0	0	2
8	CD 208	Personality development through life Enlightenment skills	2	0	0	0
				1	otal	18

<sup>\*</sup>Students are encouraged to go to industrial training/internship for at least 2-3 months during semester break.



		III SEMESTER			
S.No	Course Code	Course Name	T	P	Credits
1	CD 301	Program Elective - 5	3	0	3
	CD 3011	Non destructive Evaluation			
	CD 3012	Quality Engineering			
	CD 3013	Green Manufacturing			
	CD 3014	MOOCS/ NPTEL *			
2	CD 302	Open Elective	3	0	3
	CD 3021	Nano Technology			
	CD 3022	Optimization Techniques			
	CD 3023	Product Design and Manufacturing			
3		Project /Dissertation Phase-I	0	20	10
				Total	16

\*MOOCS/NPTEL certification courses as per the approved list of internal BOS at the time of registration.

	IV SEMESTER						
S.No	<b>Course Code</b>	Course Name	L	T	P	Credits	
1		Project /Dissertation Phase-II	0	0	32	16	
Total						16	



I Year I Semester	GEOMETRIC MODELING	L	P	С
	GEOMETRIC MODELING	3	0	3

#### Unit - I

**Cubic splines** –**I** Definition, Explicit and implicit equations, parametric equations, Algebraic and geometric form of cubic spline, Hermite cubic spline, tangent vectors, parametric space of a curve, blending functions.

#### Unit - II

#### **Cubic Splines-II:**

four point form, reparametrization, truncating and subdividing of curves. Graphic construction and interpretation, composite pc curves.

Bezier Curves: Bernstein basis, equations of Bezier curves, properties, derivatives.

#### **Unit - III**

**B-Spline Curves:** B-Spline basis, equations, knot vectors, properties, and derivatives.

#### Unit - IV

**Surfaces:** Bicubic surfaces, Coon's surfaces, Bezier surfaces, B-Spline surfaces, surfaces of revolutions, Sweep surfaces, ruled surfaces, tabulated cylinder, bilinear surfaces, Gaussian curvature.

#### Unit - V

**Solids:** Tricubic solid, Algebraic and geometric form.

**Solid modeling concepts:** Wire frames, Boundary representation, Half space modeling, spatial cell, cell decomposition, classification problem.

#### **TEXT BOOKS:**

- 1. Elements of Computer Graphics by Roger & Adams Tata McGraw Hill.
- 2. Geometric Modeling by Micheal E. Mortenson, McGraw Hill Publishers

#### **REFERENCES:**

1. Computer Aided Design and Manufacturing, K.Lalit Narayan, K.Mallikarjuna Rao, MMM Sarcar, PHI Publishers



I Year I Semester	COMPUTER AIDED MANUFACTURING	L	P	С
1 Teal 1 Semester		3	0	3

#### UNIT - I

**COMPUTER AIDED PROGRAMMING**: General information, APT programming, Examples Apt programming problems (2D machining only). NC programming on CAD/CAM systems, the design and implementation of post processors .Introduction to CAD/CAM software, Automatic Tool Path generation.

#### **UNIT - II**

**TOOLING FOR CNC MACHINES:** Interchangeable tooling system, preset and qualified tools, coolant fed tooling system, modular fixturing, quick change tooling system, automatic head changers. DNC Systems and Adaptive Control: Introduction, type of DNC systems, advantages arid disadvantages of DNC, adaptive control with optimization, Adaptive control with constrains, Adaptive control of machining processes like turning, grinding.

#### **UNIT - III**

**POST PROCESSORS FOR CNC:** Introduction to Post Processors: The necessity of a Post Processor, the general structure of a Post Processor, the functions of a Post Processor, DAPP — based-Post Processor: Communication channels and major variables in the DAPP — based Post Processor, the creation of a DAPP — Based Post Processor.

#### **UNIT - IV**

MICRO CONTROLLERS: Introduction, Hardware components, I/O pins, ports, external memory:, counters, timers and serial data I/O interrupts. Selection of Micro Controllers Embedded Controllers, Applications and Programming of Micro Controllers. Programmable Logic Controllers (PLC's): Introduction, Hardware components of PLC, System, basic structure, principle of operations, Programming mnemonics timers, Internal relays and counters, Applications of PLC's in CNC Machines.

#### UNIT - V

**COMPUTER AIDED PROCESS PLANNING**: Hybrid CAAP System, Computer Aided Inspection and quality control, Coordinate Measuring Machine, Limitations of CMM, Computer Aided Testing, Optical Inspection Methods, Artificial Intelligence and expert system: Artificial Neural Networks, Artificial Intelligence in CAD, Experts systems and its structures.

#### **TEXT BOOKS:**

- 1. Computer Control of Manufacturing Systems / Yoram Koren / Mc Graw Hill. 1983.
- 2. CAD/CAM Principles and Applications, P.N.Rao, TMH

- 1. Computer Aided Design Manufacturing K. Lalit Narayan, K. Mallikarjuna Rao and M.M.M. Sarcar, PHI, 2008.
- 2. CAD / CAM Theory and Practice, / Ibrahim Zeid, TMH
- 3. CAD / CAM / CIM, Radhakrishnan and Subramanian, New Age
- 4. Principles of Computer Aided Design and Manufacturing, Farid Amirouche, Pearson
- 5. Computer Numerical Control Concepts and programming, Warren S Seames, Thomson.



I Year I Semester	COMPUTATIONAL METHODS IN	L	P	С
	ENGINEERING (ELECTIVE I)	3	0	3

#### Unit – I

**Introduction to numerical methods applied to engineering problems:** Examples, solving sets of equations – Matrix notation – Determinants and inversion – Iterative methods – Relaxation methods – System of non-linear equations. Least square approximation fitting of non-linear curves by least squares –regression analysis- multiple linear regression, non linear regression - computer programs.

#### Unit – II

**Boundry value problems and charecteristic value problems:** Shooting method – Solution through a set of equations – Derivative boundary conditions – Rayleigh – Ritz method – Characteristic value problems.

#### Unit – III

**Transformation Techniques:** Continuous fourier series, frequency and time domains, laplace transform, fourier integral and transform, discrete fourier transform (DFT), Fast fourier transform (FFT).

#### Unit - IV

**Numerical solutions of partial differential equations:** Laplace's equations – Representations as a difference equation – Iterative methods for Laplace's equations – poisson equation – Examples – Derivative boundary conditions – Irregular and non – rectangular grids – Matrix patterns, sparseness – ADI method – Finite element method.

#### Unit - V

**Partial differential equations:** Explicit method – Crank-Nickelson method – Derivative boundary condition – Stability and convergence criteria. Solving wave equation by finite differences-stability of numerical method –method of characteristics-wave equation in two space dimensions-computer programs.

#### **TEXT BOOKS:**

- 1. Steven C.Chapra, Raymond P.Canale "Numerical Methods for Engineers" Tata Mc-Graw Hill
- 2. Curtis F. Gerald, Partick. O. Wheatly, "Applied numerical analysis" Addison-Wesley, 1989
- 3.Douglas J.Faires, Riched Burden" Numerical methods", Brooks/Cole publishing company, 1998. Second edition.

#### **References:**

- 1. Ward Cheney and David Kincaid "Numerical mathematics and computing" Brooks/Cole publishing company 1999, Fourth edition.
- 2. Riley K.F., M.P. Hobson and Bence S.J., "Mathematical methods for physics and engineering", Cambridge University press, 1999.
- 3. Kreysis, Advanced Mathematics



		L	P	C
I Year I Semester	MATERIALS TECHNOLOGY (ELECTIVE 1)	3	0	3

#### **UNIT I:**

Elasticity in metals, mechanism of plastic deformation, slip and twinning, role of dislocations, yield stress, shear strength of perfect and real crystals, strengthening mechanism, work hardening, solid solution, grain boundary strengthening. Poly phase mixture, precipitation, particle, fiber and dispersion strengthening, effect of temperature, strain and strain rate on plastic behavior, super plasticity, Yield criteria: Von-mises and Tresca criteria.

#### **UNIT II:**

Griffth's Theory, stress intensity factor and fracture Toughness, Toughening Mechanisms, Ductile and Brittle transition in steel, High Temperature Fracture, Creep, Larson – Miller parameter, Deformation and Fracture mechanism maps.

#### **UNIT III:**

Fatigue, fatigue limit, features of fatigue fracture,Low and High cycle fatigue test, Crack Initiation and Propagation mechanism and paris Law, Effect of surface and metallurgical parameters on Fatigue, Fracture of non-metallic materials, fatigue analysis, Sources of failure, procedure of failure analysis. Motivation for selection, cost basis and service requirements, Selection for Mechanical Properties, Strength, Toughness, Fatigue and Creep.

#### **UNIT IV:**

Modern Metallic Materials: Dual Steels, Micro alloyed, High Strength Low alloy (HSLA) Steel, Transformation induced plasticity (TRIP) Steel, Maraging Steel, Inter metallics, Ni and Ti Aluminides. Processing and applications of Smart Materials, Shape Memory alloys, Metallic Glass Quasi Crystal and Nano Crystalline Materials.

#### **UNIT V:**

Nonmetallic Materials: Polymeric materials and their molecular structures, Production Techniques for Fibers, Foams, Adhesives and Coatings, structure, Properties and Applications of Engineering Polymers, Advanced Structural Ceramics WC, TiC, TaC, A1<sub>2</sub>O<sub>3</sub>, SiC, Si<sub>3</sub>N<sub>4</sub>, CBN and Diamond – properties, Processing and applications.

#### **TEXT BOOKS:**

- 1. Mechanical Behavior of Materials/Thomas H. Courtney/ McGraw Hill/2 nd Edition/2000
- 2. Mechanical Metallurgy/George E. Dicter/McGraw Hill, 1998.

- 1 Selection and use of Engineering Materials 3e/Charles J.A/Butterworth Heiremann.
- 2 Engineering Materials Technology/James A Jacob Thomas F Kilduff/Pearson
- 3 Material Science and Engineering/William D Callister/John Wiley and Sons
- 4 Plasticity and plastic deformation by Aritzur.
- 5 Introduction to Ceramics, 2nd Edition by W. David Kingery, H. K. Bowen, Donald R. Uhlmann



		L	P	C
I Year I Semester	MECHANICAL VIBRATIONS			
	(PROGRAM ELECTIVE-1)	3	0	3

#### Unit I

**Single degree of Freedom systems:** Undamped and damped free vibrations: forced vibrations; coulomb damping; Response to harmonic excitation; rotating unbalance and support excitation, Vibration isolation and transmissibility, Vibrometers, velocity meters & accelerometers.

#### **Unit II**

Response to Non Periodic Excitations: unit Impulse, unit step and unit Ramp functions; response to arbitrary excitations, The Convolution Integral; shock spectrum; System response by the Laplace Transformation method.

#### **Unit III**

**Multi degree freedom systems:** Principal modes – undamped and damped free and forced vibrations; undamped vibration absorbers, Matrix formulation, stiffness and flexibility influence coefficients; Eigen value problem; normal modes and their properties; Free and forced vibration by Modal analysis; Method of matrix inversion; Torsional vibrations of multi – rotor systems and geared systems; Discrete-Time systems.

#### **Unit IV**

**Numerical Methods:** Rayliegh's, Stodola's, Matrix iteration, Rayleigh-Ritz Method and Holzer's methods

#### Unit V

**Application of concepts:** Free vibration of strings – longitudinal oscillations of bars-transverse vibrations of beams- Torsional vibrations of shafts. Critical speeds without and with damping, secondary critical speed.

#### **Text books:**

- 1. Elements of Vibration Analysis by Meirovitch.
- 2. Mechanical Vibrations by G.K. Groover.

#### **References:**

- 1. Vibrations by W.T. Thomson
- 2. Mechanical Vibrations Schaum series.
- 3. Vibration problems in Engineering by S.P. Timoshenko.
- 4. Mechanical Viabrations V.Ram Murthy.



		L	P	C
I Year I Semester	MECHATRONICS (PROGRAM ELECTIVE-1)	3	0	3
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#### **UNIT-I**

Mechatronics systems, elements, levels of mechatronics system, Mechatronics design process, system, measurement systems, control systems, microprocessor-based controllers, advantages and disadvantages of mechatronics systems. Sensors and transducers, types, displacement, position, proximity, velocity, motion, force, acceleration, torque, fluid pressure, liquid flow, liquid level, temperature and light sensors.

#### **UNIT-II**

Solid state electronic devices, PN junction diode, BJT, FET, DIA and TRIAC. Analog signal conditioning,

#### **UNIT-III**

Hydraulic and pneumatic actuating systems, Fluid systems, Hydraulic and pneumatic systems, components, control valves, electro-pneumatic, hydro-pneumatic, electro-hydraulic servo systems: Mechanical actuating systems and electrical actuating systems.

#### **UNIT-IV**

Digital electronics and systems, digital logic control, micro processors and micro controllers, programming, process controllers, programmable logic controllers, PLCs versus computers, application of PLCs for control.

#### **UNIT-V**

System and interfacing and data acquisition, DAQS, SCADA, A to D and D to A conversions; Dynamic models and analogies, System response. Design of mechatronics systems & future trends.

#### **TEXT BOOKS:**

- MECHATRONICS Integrated Mechanical Electronics Systems/KP Ramachandran & GK Vijaya Raghavan/WILEY India Edition/2008
- 2. Mechatronics Electronics Control Systems in Mechanical and Electrical Engineering by W Bolton, Pearson Education Press, 3rd edition, 2005.

- 1 Mechatronics Source Book by Newton C Braga, Thomson Publications, Chennai.
- 2 Mechatronics N. Shanmugam / Anuradha Agencies Publishers.
- 3 Mechatronics System Design / Devdas shetty/Richard/Thomson.
- 4 Mechatronics/M.D.Singh/J.G.Joshi/PHI.
- 5 Mechatronics Electronic Control Systems in Mechanical and Electrical Engg. 4<sup>th</sup> Edition, Pearson, 2012 W. Bolton
- 6 Mechatronics Principles and Application Godfrey C. Onwubolu, Wlsevier, 2006 Indian print



I Year I Semester	INDUSTRIAL ROBOTICS (PROGRAM ELECTIVE-1)	L	P	С
	(FROGRAM ELLOTTVL 1)	3	0	3

#### UNIT - I

**INTRODUCTION**: Automation and Robotics, Robot anatomy, robot configuration, motions joint notation scheme, work volume, robot drive systems, control systems and dynamic performance, precision of movement.

**CONTROL SYSTEM AND COMPONENTS:** basic concepts and motion controllers, control system analysis, robot actuation and feedback components, Positions sensors, velocity sensors, actuators, power transmission systems, robot joint control design.

#### UNIT - II

**MOTION ANALYSIS AND CONTROL:** Manipulator kinematics, position representation, forward and inverse transformations, homogeneous transformations, manipulator path control, robot arm dynamics, configuration of a robot controller.

#### **UNIT - III**

**END EFFECTORS:** Grippers-types, operation, mechanism, force analysis, tools as end effectors consideration in gripper selection and design. SENSORS: Desirable features, tactile, proximity and range sensors, uses sensors in robotics.

**MACHINE VISION:** Functions, Sensing and Digitizing-imaging devices, Lighting techniques, Analog to digital single conversion, image storage: Image processing and Analysis-image data reduction, Segmentation, feature extraction, Object recognition. Training the vision system, Robotic application.

#### **UNIT - IV**

**ROBOT PROGRAMMING:** Lead through programming, Robot program as a path in space, Motion interpolation, WAIT, SIGNAL AND DELAY commands, Branching, capabilities and Limitations of lead through methods.

**ROBOT LANGUAGES**: Textual robot Languages, Generations of robot programming languages, Robot language structures, Elements and function.

#### UNIT - V

**ROBOT CELL** DESGIN AND CONTROL: Robot cell layouts-Robot centered cell, In-line robot cell, Considerations in work design, Work and control, Inter locks, Error detection, Work cell controller.

**ROBOT APPLICATION**: Material transfer, Machine loading/unloading, Processing operation, Assembly and Inspection, Future Application.

#### **TEXT BOOKS:**

- 1. Industrial Robotics / Groover M P / Pearson Edu.
- 2. Introduction to Robotic Mechanics and Control by JJ Craig, Pearson, 3rd edition.

- 1 Robotics / Fu K S/ McGraw Hill.
- 2 Robotic Engineering / Richard D. Klafter, Prentice Hall
- 3 Robot Analysis and Intelligence / Asada and Slotine / Wiley Inter-Science.
- 4 Robot Dynamics & Control Mark W. Spong and M. Vidyasagar / John Wiley
- 5 Introduction to Robotics by SK Saha, The McGrah Hill Company, 6<sup>th</sup>, 2012
- 6 Robotics and Control / Mittal R K & Na
- 7 grath I J / TMH



I Year I Semester	SIMULATION OF MANUFACTURING	L	P	C
	SYSTEMS (PROGRAM ELECTIVE-1)	3	0	3

#### Unit-I

**Introduction to System and simulation:** Concept of system and elements of system, Discrete and continuous system, Models of system and Principles of modeling and simulation, Monte carlo simulation, Types of simulation, Steps in simulation model, Advantages, limitations and applications of simulation, Applications of simulation in manufacturing system

#### **Unit-II**

**Review of statistics and probability:** Types of discrete and continuous probability distributions such as Geometric, Poisson, Uniform, Geometric distribution with examples, Normal, Exponential distribution with examples.

#### **Unit-III**

**Random numbers:** Need for RNs, Technique for Random number generation such as Mid product method, Mid square method, and Linear congruential method with examples Test for Random numbers: Uniformity - Chi square test or Kolmogorov Smirnov test, Independency- Auto correlation test

Random Variate generation: Technique for Random variate generation such as Inverse transforms technique or Rejection method

#### **Unit-IV**

**Analysis of simulation data:** Input data analysis, Verification and validation of simulation models, Output data analysis

Simulation languages: History of simulation languages, Comparison and selection of simulation languages

Design and evaluation of simulation experiments: Development and analysis of simulation models using simulation language with different manufacturing systems

#### Unit-V

**Queueing models:** An introduction, M/M/1 and M/M/m Models with examples, Open Queueing and Closed queueing network with examples

**Markov chain models and others:** Discrete time markov chain with examples, Continues time markov chain with examples, stochastic process in manufacturing, Game theory

#### **TEXT BOOKS:**

- 1. J.Banks, J.S. Carson, B. L. Nelson and D.M. Nicol, "Discrete Event System Simulation", PHI, New Delhi, 2009.
- 2. A.M. Law and W.D.Kelton, "Simulation Modeling and Analysis", Tata McGraw Hill Ltd, New Delhi, 2008.
- 3. N. Viswanadham and Y. Narahari, "Performance Modeling of Automated Manufacturing Systems", PHI, New Delhi, 2007



I Year I Semester	ADVANCED CADIAD	L	P	С
	ADVANCED CAD LAB	0	4	2

Students shall carry out the modeling and FE analysis of the following to predict deflection and stress distributions:

- 1. Trussess -2D and 3D
- 2.Beams
- 3. Plate with Plane stress condition
- 4. Plate with Plane strain condition
- 5. Cylinders Axi-symmetric condition
- 6. Natural frequencies of Beam



I Year I Semester ADVANCED MANUFACTURING LAB	L	P	С
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#### Students shall carry out the experiments on the following:

- 1. Casting processes Study of Solidification, temperatures, metallurgical phases.
- 2. Forging processes Study of hot working processes and extrusion
- 3. Forming Processes Study of blanking, bending and deep drawing
- 4. Welding Processes Study of arc, and spot welding processes
- 5. Powder metallurgy- Study of Green Density and sintering density
- 6. Additive Manufacturing Study of simple parts in 3D printing
- 7. Machining- Estimation of chip reduction coefficient and shear angle in orthogonal turning,

Measurement of cutting forces and average cutting temperature, and Estimation of tool life of a single point turning tool.



I Year I Semester	Research Methodology and IPR	L	P	C
	Research Methodology and II K	2	0	2

**Unit 1:** Meaning of research problem, Sources of research problem, Criteria Characteristics of a good research problem, Errors in selecting a research problem, Scope and objectives of research problem. Approaches of investigation of solutions for research problem, data collection, analysis, interpretation, Necessary instrumentations

**Unit 2:** Effective literature studies approaches, analysis Plagiarism, Research ethics, Effective technical writing, how to write report, Paper Developing a Research Proposal, Format of research proposal, a presentation and assessment by a review committee

**Unit 3:** Nature of Intellectual Property: Patents, Designs, Trade and Copyright. Process of Patenting and Development: technological research, innovation, patenting, development. International Scenario: International cooperation on Intellectual Property. Procedure for grants of patents, Patenting under PCT.

**Unit 4:** Patent Rights: Scope of Patent Rights. Licensing and transfer of technology. Patent information and databases. Geographical Indications.

**Unit 5:** New Developments in IPR: Administration of Patent System. New developments in IPR; IPR of Biological Systems, Computer Software etc. Traditional knowledge Case Studies, IPR and IITs.

#### **References:**

- (1) Stuart Melville and Wayne Goddard, "Research methodology: an introduction for science & engineering students"
- (2) Wayne Goddard and Stuart Melville, "Research Methodology: An Introduction"
- (3) Ranjit Kumar, 2nd Edition, "Research Methodology: A Step by Step Guide for beginners"
- (4) Halbert, "Resisting Intellectual Property", Taylor & Francis Ltd ,2007.
- (5) Mayall, "Industrial Design", McGraw Hill, 1992.
- (6) Niebel, "Product Design", McGraw Hill, 1974.
- (7) Asimov, "Introduction to Design", Prentice Hall, 1962.
- (8) (8) Robert P. Merges, Peter S. Menell, Mark A. Lemley, "Intellectual Property in New Technological Age", 2016.
- (9) T. Ramappa, "Intellectual Property Rights Under WTO", S. Chand, 2008



I Year I Semester	WRITING SKILLS FOR SCIENTIFIC	L	P	C
	COMMUNICATION	2	0	0

#### Unit-1:

Planning and Preparation, Word Order, Breaking up long sentences, Structuring Paragraphs and Sentences, Being Concise and Removing Redundancy, Avoiding Ambiguity and Vagueness, Clarifying Who Did What, Highlighting Your Findings, Hedging and Criticising.

**Unit-2:** Paraphrasing and Plagiarism, Sections of a Paper, Abstracts, Review of the Literature, Methods, Results, Discussion, Conclusions, The Final Check.

#### Unit-3:

Key skills are needed when writing a Title, key skills are needed when writing an Abstract, key skills are needed when writing an Introduction, skills needed when writing a Review of the Literature.

#### Unit-4:

Skills are needed when writing the Methods, skills needed when writing the Results, skills are needed when writing the Discussion, skills are needed when writing the Conclusions.

#### Unit-5:

Useful phrases, how to ensure paper is as good as it could possibly be the first-time submission

#### **Suggested Studies:**

- 1. Goldbort R (2006) Writing for Science, Yale University Press (available on Google Books)
- 2. Day R (2006) How to Write and Publish a Scientific Paper, Cambridge University Press
- 3. Highman N (1998), Handbook of Writing for the Mathematical Sciences, SIAM. Highman'sbook.
- $4. \ Adrian \ Wallwork \ , English \ for \ Writing \ Research \ Papers, \ Springer \ New \ York \ Dordrecht \ Heidelberg \ London, \ 2011$



I Year II Semester	THEORY OF ELASTICITY AND	L	P	C
	PLASTICITY	3	0	3

#### **UNIT-I**

**INTRODUCTION:** Elasticity –Notation for forces and stresses-Components of stresses – components of strain –Hooke's law.

**PLANE STRESS AND PLANE STRAIN ANALYSIS:** Plane stress-plane strain-Differential equations of equilibrium- Boundary conditions- Compatibility equations-stress function-Boundary conditions.

#### **UNIT-II**

**TWO DIMENSIONAL PROBLEMS IN RECTANGULAR COORDINATES:** Solution by polynomials-Saint Venant's principle-Determination of displacements-bending of simple beamsapplication of Fourier series for two dimensional problems - gravity loading.

**TWO DIMENSIONAL PROBLEMS IN POLAR COORDINATES**: General Equation in polar co-ordinates - stress distribution symmetrical about an axis –Pure bending of curved bars- strain components in polar coordinates-Displacements for symmetrical stress distributions-simple symmetric and asymmetric problems-General solution of two dimensional problem in polar coordinates-Application of the general solution of two dimensional problem in polar coordinates-Application of the general solution in polar coordinates.

#### **UNIT-III**

**ANALYSIS OF STRESS AND STRAIN IN THREE DIMENSIONS:** Principle stress - ellipsoid and stress-director surface-Determination of principle stresses- Maximum shear stresses-Homogeneous deformation-principle axis of strain rotation.

**GENERAL THEOREMS:** Balance laws - Differential equations of equilibrium- conditions of compatibility - Determination of displacement-Equations of equilibrium in terms of displacements-principle of superposition-Uniqueness of solution —the Reciprocal theorem.

#### **UNIT-IV**

**TORSION OF PRISMATIC BARS:** General solution of problems by displacement (St. Venant's warping function) & force (Prandtl's stress function) approaches - Membrane analogy - Torsion of circular and non-circular (elliptic and rectangular) sections - Torsion of thin rectangular section and hollow thin walled section - Single and multi-celled sections.

#### **UNIT-V**

**THEORY OF PLASTICITY:** Stress-strain curve - Theories of strength and failure – Yield Criteria - Yield Surface – Plastic Flow – Plastic Work – Plastic Potential – Strain hardening

#### **Text Books:**

- 1. Timoshenko, S., Theory of Elasticity and Plasticity, MC Graw Hill Book company.
- 2. Sadhu Singh, Theory of Elasticity and Plasticity, Khanna Publishers.

#### **Reference Books:**

- 1. Papov, Advanced Strength of materials, MC Graw Hill Book Company.
- 2. Chen, W.F. and Han, D.J, Plasticity for structural Engineers, Springer-Verlag, New York.
- 3. Lubliner, J., Plasticity Theory, Mac Millan Publishing Co., New York.
- 4. Y.C.Fung., Foundations of Solid Mechanics, Prentice Hall India



		L	P	C
I Year II Semester	ADVANCED MANUFACTURING	3	0	3
	PROCESSES			

#### UNIT-I

**SURFACE TREATMENT:** Scope, Cleaners, Methods of cleaning, Surface coating types, ceramic and organic methods of coating, and economics of coating. Electro forming, Chemical vapor deposition, Physical vapor deposition, thermal spraying, Ion implantation, diffusion coating, Diamond coating and cladding.

UNIT- II

**PROCESSING OF CERAMICS:** Applications, characteristics, classification .Processing of particulate ceramics, Powder preparations, consolidation, hot compaction, drying, sintering, and finishing of ceramics, Areas of application.

**PROCESSING OF COMPOSITES:** Composite Layers, Particulate and fiber reinforced composites, Elastomers, Reinforced plastics, MMC, CMC, Polymer matrix composites.

**UNIT-III** 

#### FABRICATION OF MICROELECTRONIC DEVICES:

Crystal growth and wafer preparation, Film Deposition oxidation, lithography, bonding and packaging, reliability and yield, Printed Circuit boards, computer aided design in micro electronics, surface mount technology, Integrated circuit economics.

**UNIT - IV** 

**ADVANCED MACHINING PROCESSES:** AJM, WJM, WireEDM, ECM, LBM, EBM, PAM – Principle, working, limitations and applications.

**UNIT-V** 

**RAPID PROTOTYPING:** Working Principles, Methods, Stereo Lithography, Laser Sintering, Fused Deposition Method, Applications and Limitations, Rapid tooling, Techniques of rapid manufacturing **TEXT BOOKS:** 

- 1. Manufacturing Engineering and Technology I Kalpakijian / Adisson Wesley, 1995.
- 2. Process and Materials of Manufacturing / R. A. Lindburg / 1th edition, PHI 1990.

- 1 Microelectronic packaging handbook / Rao. R. Thummala and Eugene, J. Rymaszewski / Van Nostrand Renihold,
- 2 MEMS & Micro Systems Design and manufacture / Tai Run Hsu / TMGH
- 3 Advanced Machining Processes / V.K.Jain / Allied Publications.
- 4 Introduction to Manufacturing Processes / John A Schey Mc Graw Hill.



I Year II Semester	ADVANCED FINITE ELEMENT	L	P	C
	METHODS			
	(PROGRAM ELECTIVE-3)	3	0	3

#### UNIT - I

**Formulation Techniques:** Methodology, Engineering problems and governing differential equations, finite elements., Variational methods-potential energy method, Raleigh Ritz method, strong and weak forms, Galerkin and weighted residual methods, calculus of variations, Essential and natural boundary conditions.

#### UNIT - II

**One-dimensional elements:** Bar, trusses, beams and frames, displacements, stresses and temperature effects.

#### UNIT - III

**Two dimensional problems:** CST, LST, four noded and eight nodded rectangular elements, Lagrange basis for triangles and rectangles, serendipity interpolation functions. Axisymmetric Problems: Axisymmetric formulations, Element matrices, boundary conditions. Heat Transfer problems: Conduction and convection, examples: - two-dimensional fin.

#### UNIT - IV

**Isoparametric formulation:** Concepts, sub parametric, super parametric elements, numerical integration, Requirements for convergence, h-refinement and p-refinement, complete and incomplete interpolation functions, pascal's triangle, Patch test.

#### UNIT - V

Finite elements in Structural Analysis: Static and dynamic analysis, eigen value problems, and their solution methods, case studies using commercial finite element packages.

#### TEXT BOOK:

1. Finite element methods by Chandrubatla&Belagondu.

- 1.J.N. Reddy, Finite element method in Heat transfer and fluid dynamics, CRC press, 1994
- 2. Zienckiwicz O.C. & R. L. Taylor, Finite Element Method, McGraw-Hill, 1983.
- 3. K. J. Bathe, Finite element procedures, Prentice-Hall, 1996



I Year II Semester	FRACTURE MECHANICS	L	P	С
	(PROGRAM ELECTIVE-3)	3	0	3

#### **UNIT-I**

**Introduction:** Prediction of mechanical failure. Macroscopic failure modes; brittle and ductile behaviour. Fracture in brittle and ductile materials – characteristics of fracture surfaces; intergranular and intra-granular failure, cleavage and micro-ductility, growth of fatigue cracks, The ductile/brittle fracture transition temperature for notched and unnotched components. Fracture at elevated temperature.

#### **UNIT-II**

**Griffiths analysis:** Concept of energy release rate, G, and fracture energy, R. Modification for ductile materials, loading conditions. Concept of R curves.

**Linear Elastic Fracture Mechanics, (LEFM).** Three loading modes and the state of stress ahead of the crack tip, stress concentration factor, stress intensity factor and the material parameter the critical stress intensity factor, crack tip plasticity, effect of thickness on fracture toughness.

#### **UNIT-III**

**Elastic-Plastic Fracture Mechanics**; (**EPFM**) The definition of alternative failure prediction parameters, Crack Tip Opening Displacement, and the J integral. Measurement of parameters and examples of use.

#### **UNIT-IV**

**Fatigue:** definition of terms used to describe fatigue cycles, High Cycle Fatigue, Low Cycle Fatigue, mean stress R ratio, strain and load control. S-N curves. Goodmans rule and Miners rule. Micro-mechanisms of fatigue damage, fatigue limits and initiation and propagation control, leading to a consideration of factors enhancing fatigue resistance. Total life and damage tolerant approaches to life prediction.

#### **UNIT-V**

**Creep deformation:** the evolution of creep damage, primary, secondary and tertiary creep. Micro-mechanisms of creep in materials and the role of diffusion. Ashby creep deformation maps. Stress dependence of creep – power law dependence. Comparison of creep performance under different conditions – extrapolation and the use of Larson-Miller parameters. Creep-fatigue interactions. Examples.

#### **TEXT BOOKS:**

- 1. T.L. Anderson, Fracture Mechanics Fundamentals and Applications, 2nd Ed. CRC press, (1995)
- 2. J.F. Knott, Fundamentals of Fracture Mechanics, Butterworths (1973)
- 3. G. E. Dieter, Mechanical Metallurgy, McGraw Hill, (1988)
- 4. S. Suresh, Fatigue of Materials, Cambridge University Press, (1998)



- 1. B. Lawn, Fracture of Brittle Solids, Cambridge Solid State Science Series 2nd ed1993.
- 2. J.F. Knott, P Withey, Worked examples in Fracture Mechanics, Institute of Materials.
- 3. H.L.Ewald and R.J.H. Wanhill Fracture Mechanics, Edward Arnold, (1984).
- 4. L.B. Freund and S. Suresh, Thin Film Materials Cambridge University Press, (2003).
- 5. D.C. Stouffer and L.T. Dame, Inelastic



I Year II Semester	PRODUCT DESIGN AND	L	P	C
	DEVELOPMENT	3	0	3
	(PROGRAM ELECTIVE-3)			

#### **UNIT I**

Introduction:Classification/Specifications of Products, Product life cycle. Product mix, Introduction to product design, Modern product development process, Innovative thinking.

#### **UNIT II**

Morphology of design. Conceptual Design: Generation, selection & embodiment of concept.Product architecture, Industrial design: process, need, Robust Design: Taguchi Designs & DOE, Design Optimization.

#### **UNIT III**

Design for Mfg& Assembly: Methods of designing for Manufacturing and assembly, Designs for Maintainability, Designs for Environment, Product costing, Legal factors and social issues, Engineering ethics and issues of society related to design of products. Value Engineering / Value Analysis.: Definition. Methodology, Case studies.

#### **UNIT IV**

Economic analysis: Qualitative & Quantitative. Ergonomics / Aesthetics: Gross human autonomy, Anthropometry, Man-Machine interaction, Concepts of size and texture, colour .Comfort criteria, Psychological & Physiological considerations.

#### **UNIT V**

Creativity Techniques: Creative thinking, conceptualization, brain storming, primary design, drawing, simulation, detail design. Concurrent Engineering, Rapid prototyping, Tools for product design – Drafting / Modeling software, CAM Interface, Patents & IP Acts. Overview, Disclosure preparation.

#### **Text Books:**

- 1. Karl T Ulrich, Steven D Eppinger , "Product Design & Development." Tata McGrawhill New Delhi 2003.
- 2. David G Ullman, "The Mechanical Design Process." McGrawhill Inc Singapore 1992 N J M Roozenberg, J Ekels, N F M Roozenberg "Product Design Fundamentals and Methods." John Willey & Sons 1995.
- 3. Kevin Otto & Kristin Wood Product Design: "Techniques in Reverse Engineering and New Product Development." 1 / e 2004, Pearson Education New Delhi. References:
- 4. L D Miles "Value Engineering."
- 5. Hollins B & Pugh S "Successful Product Design." Butter worths London.
- 6. Baldwin E N & Neibel B W "Designing for Production." Edwin Homewood Illinois
- 7. Jones J C "Design Methods." Seeds of Human Futures. John Willey New York.
- 8. Bralla J G "Handbook of Product Design for Manufacture, McGrawhillNewYork



	MATERIALS CHARACTERIZATION	L	P	C
I Year II Semester	TECHNIQUES	3	0	3
	(PROGRAM ELECTIVE-4)			

#### **UNIT I**

Introduction to materials and Techniques, Structure analysis tools: X-ray diffraction: phase identification, indexing and lattice parameter determination, Analytical line profile fitting using various models, Neutron diffraction, Reflection High Energy Electron Diffraction, and Low Energy Electron Diffraction.

#### **UNIT II**

Microscopy techniques: Optical microscopy, transmission electron microscopy (TEM), energy dispersive X-ray microanalysis (EDS), scanning electron microscopy (SEM), Rutherford backscattering spectrometry (RBS), atomic force microscopy (AFM) and scanning probe microscopy (SPM).

#### **UNIT III**

Thermal analysis technique: Differential thermal analysis (DTA), Differential Scanning Calorimetry (DSC), Thermogravimetric analysis (TGA); Electrical characterization techniques: Electrical resistivity, Hall effect, Magnetoresistance.

#### **UNIT IV**

Magnetic characterization techniques: Introduction to Magnetism, Measurement Methods, Measuring Magnetization by Force, Measuring Magnetization by Induction method, Types of measurements using magnetometers: M-H loop, temperature dependent magnetization, time dependent magnetization, Measurements using AC susceptibility, Magneto-optical Kerr effect, Nuclear Magnetic Resonance, Electron Spin Resonance.

#### **UNIT V**

Optical and electronic characterization techniques: UV-VIS spectroscopy, Fourier transform infrared spectroscopy, Raman spectroscopy, X-ray photoelectron spectroscopy.

#### **TEXT BOOKS:**

- 1. Characterization of Materials (Materials Science and Technology: A Comprehensive Treatment, Vol 2A & 2B, VCH (1992).
- 2. Semiconductor Material and Device Characterization, 3<sup>rd</sup>Edition, D. K. Schroder, Wiley-IEEE Press (2006).
- 3. Materials Characterization Techniques, S Zhang, L. Li andshok Kumar, CRC Press (2008).

- 1. Physical methods for Materials Characterization, P. E. J.Flewitt and R K Wild, IOP Publishing (2003).
- 2. Characterization of Nanophase materials, Ed. Z L Wang, Willet-VCH (2000).



I Year II Semester	OPTIMIZATION AND RELIABILITY	L	P	С
	(PROGRAM ELECTIVE-4)	3	0	3

#### UNIT - I

**CLASSICAL OPTIMIZATION TECHNIQUES:** Single variable optimization with and without constraints, multi – variable optimization without constraints, multi – variable optimization with constraints – method of Lagrange multipliers, Kuhn-Tucker conditions, merits and demerits of classical optimization techniques.

#### UNIT - II

**NUMERICAL METHODS FOR OPTIMIZATION:** Nelder Mead's Simplex search method, Gradient of a function, Steepest descent method, Newton's method, Pattern search methods, conjugate method, types of penalty methods for handling constraints, advantages of numerical methods.

#### **UNIT - III**

**GENETIC ALGORITHM** (**GA**): Differences and similarities between conventional and evolutionary algorithms, working principle, reproduction, crossover, mutation, termination criteria, different reproduction and crossover operators, GA for constrained optimization, draw backs of GA, **GENETIC PROGRAMMING** (**GP**): Principles of genetic programming, terminal sets, functional sets, differences between GA & GP, random population generation, solving differential equations using GP.

**MULTI-OBJECTIVE GA:** Pareto's analysis, Non-dominated front, multi – objective GA, Non-dominated sorted GA, convergence criterion, applications of multi-objective problems .

#### UNIT - IV

#### APPLICATIONS OF OPTIMIZATION IN DESIGN AND MANUFACTURING SYSTEMS:

Some typical applications like optimization of path synthesis of a four-bar mechanism, minimization of weight of a cantilever beam, optimization of springs and gears, general optimization model of a machining process, optimization of arc welding parameters, and general procedure in optimizing machining operations sequence.

#### **UNIT V**

**RELIABILITY:** Concepts of Engineering Statistics, risk and reliability, probabilistic approach to design, reliability theory, design for reliability, numerical problems, hazard analysis.

#### **TEXT BOOKS:**

- 1. Optimization for Engineering Design Kalyanmoy Deb, PHI Publishers
- 2. Engineering Optimization S.S.Rao, New Age Publishers
- 3. Reliability Engineering by L.S.Srinath
- 4. Multi objective genetic algorithm by Kalyanmoy Deb, PHI Publishers.



- 1. Genetic algorithms in Search, Optimization, and Machine learning D.E.Goldberg, Addison-Wesley Publishers
- 2. Multi objective Genetic algorithms Kalyanmoy Deb, PHI Publishers
- 3. Optimal design Jasbir Arora, Mc Graw Hill (International) Publishers
- 4. An Introduction to Reliability and Maintainability Engineering by CE Ebeling, Waveland Printers Inc., 2009
- 5. Reliability Theory and Practice by I Bazovsky, Dover Publications, 2013



I Year II Semester	ADDITIVE MANUFACTURING	L	P	C
	(PROGRAM ELECTIVE-4)	3	0	3

#### UNIT I

Additive Manufacturing Process: Basic Principles of the Additive Manufacturing Process, Generation of Layer Information, Physical Principles for Layer Generation. Elements for Generating the Physical Layer, Classification of Additive Manufacturing Processes, Evaluation of the Theoretical Potentials of Rapid Prototyping Processes.

#### UNIT II

Machines for Rapid Prototyping: Overview of Polymerization: Stereolithography (SL), Sintering/Selective Sintering: Melting in the Powder Bed, Layer Laminate Manufacturing (LLM) and Three-Dimensional Printing (3DP).

#### **UNIT III**

Rapid Prototyping: Classification and Definition, Strategic Aspects for the Use of Prototypes, Applications of Rapid Prototyping in Industrial Product Development. Rapid Tooling: Classification and Definition of Terms, Properties of Additive Manufactured Tools, Indirect Rapid

#### **UNIT IV**

Tooling Processes: Molding Processes and Follow-up Processes, Indirect Methods for the Manufacture of Tools for Plastic Components, Indirect Methods for the Manufacture of Metal Components.

#### **UNIT V**

Direct Rapid Tooling Processes: Prototype Tooling: Tools Based on Plastic Rapid Prototyping Models and Methods, Metal Tools Based on Multilevel AM Processes, Direct Tooling: Tools Based on Metal Rapid Prototype Processes.

#### **Text Books:**

- 1. Andreas Gebhardt Jan-Steffen Hötter, Additive Manufacturing: 3D Printing for Additi
- Ian Gibson, David Rosen, Brent Stucker, Additive Manufacturing Technologies: 3D
   Printing, Rapid Prototyping, and Direct Digital Manufacturing, Second Edition, Springer

   New York Heidelberg Dordrecht London.

#### **References:**

- 1. Liou L.W. and Liou F.W., "Rapid Prototyping and Engineering applications: A tool box for prototype development", CRC Press, 2007.
- 2. Kamrani A.K. and Nasr E.A., "Rapid Prototyping: Theory and practice", Springer, 2006. 3. Hilton P.D. and Jacobs P.F., "Rapid
- 3. Tooling: Technologies and Industrial Applications", CRC press, 2000.



I Voor II Comestor	MATERIAL CHARACTRIZATION	L	P	C
I Year II Semester	LAB	0	4	2

- (1) Microscopy: Different microscopy techniques, Resolution, Magnification, Depth of field Imaging theory and concepts.
- (2) Optical Microscopy: Grain size estimation, Phase Percentage Estimation
- (3) Micro hardness evaluation of Ferrous and Non ferrous metals.
- (4) Testing of Tensile Properties of mild steel material
- (5) Fatigue Test
- (6) Testing of Flexural Strength on Ferrous metals.
- (7) Evaluation of Tribological properties of Ferrous and Non ferrous metals through Pin on Disc Tester.



I Year II Semester	SIMULATION OF MANUFACTURING	L	P	С
	SYSTEMS LAB	0	4	2

### students shall carry out the modeling and FE analysis of the following:

- 1. Casting processes Study of Solidification, temperatures, Residual stresses, metallurgical phases etc.
- 2. Forging processes Study of cold working and hot working processes for extrusion, drawing, rolling, etc.
- 3. Forming Processes Study of blanking, bending, deep drawing, etc.
- 4. Welding Processes Study of arc, spot, laser welding, etc



I Year II Semester	MINI PROJECT WITH SEMINAR	L	P	С
		2	0	2



I Year II Semester	PERSONALITY DEVELOPMENT THROUGH LIFE ENLIGHTENMENT	L	P	С
	SKILLS	2	0	0

#### **UNIT I**

Introduction to Personality Development The concept of personality - Dimensions of personality - Theories of Freud & Erickson-Significance of personality development. The concept of success and failure: What is success? - Hurdles in achieving success - Overcoming hurdles - Factors responsible for success - What is failure - Causes of failure. SWOT analysis.

#### UNIT II

Attitude & Motivation Attitude - Concept - Significance - Factors affecting attitudes - Positive attitude - Advantages -Negative attitude - Disadvantages - Ways to develop positive attitude - Differences between personalities having positive and negative attitude. Concept of motivation - Significance - Internal and external motives - Importance of self- motivation- Factors leading to demotivation

#### UNIT III

Self-esteem Term self-esteem - Symptoms - Advantages - Do's and Don'ts to develop positive self-esteem - Low selfesteem - Symptoms - Personality having low self esteem - Positive and negative self esteem. Interpersonal Relationships - Defining the difference between aggressive, submissive and assertive behaviours - Lateral thinking.

#### **UNIT IV**

Other Aspects of Personality Development Body language - Problem-solving - Conflict and Stress Management - Decision-making skills - Leadership and qualities of a successful leader - Character building -Team-work - Time management - Work ethics -Good manners and etiquette.

#### **UNIT V**

Employability Quotient Resume building- The art of participating in Group Discussion – Facing the Personal (HR & Technical) Interview -Frequently Asked Questions - Psychometric Analysis - Mock Interview Sessions.

#### **Text Books:**

- 1. Hurlock, E.B (2006). Personality Development, 28th Reprint. New Delhi: Tata McGraw Hill.
- 2. Stephen P. Robbins and Timothy A. Judge(2014), Organizational Behavior 16th Edition: Prentice Hall. Reference Books:
- 1. Andrews, Sudhir. How to Succeed at Interviews. 21st (rep.) New Delhi. Tata McGraw-Hill 1988.
- 2. Heller, Robert. Effective leadership. Essential Manager series. Dk Publishing, 2002
- 3. Hindle, Tim. Reducing Stress. Essential Manager series. Dk Publishing, 2003
- 4. Lucas, Stephen. Art of Public Speaking. New Delhi. Tata Mc-Graw Hill. 2001
- 5. Mile, D.J Power of positive thinking. Delhi. Rohan Book Company, (2004).
- 6. Pravesh Kumar. All about Self- Motivation. New Delhi. Goodwill Publishing House. 2005.



II Year I Semester	NON DESTRUCTIVE EVALUATION (PROGRAMELECTIVE-5)	L	P	С
	(I ROGRINELLE II (L 3)	3	0	3

#### UNIT - I

General Methods: Flaw Detection Using Dye Penetrants. Magnetic Particle Inspection, introduction to electrical impedance, Principles of Eddy Current testing, Flaw detection using eddy currents.

#### UNIT - II

X-Ray Radiography: The Radiographic process, X-Ray and Gamma-ray sources, Geometric Principles, Factors Governing Exposure, Radio graphic screens, Scattered radiation, Arithmetic of exposure, Radiographic image quality and detail visibility, Industrial X-Ray films, Fundamentals of processing techniques, Process control, The processing Room, Special Processing techniques, Paper Radiography, Sensitometric characteristics of x-ray films, Film graininess signal to noise ratio in radiographs, The photographic latent image, Radiation Protection.

#### UNIT - III

Generation of ultrasonic waves, Horizontal and shear waves, Near field and far field acoustic wave description, Ultrasonic probes- straight beam, direct contact type, Angle beam, Transmission/reflection type, and delay line transducers, acoustic coupling and media, Transmission and pulse echo methods, A-scan, B-scan, C-scan, F-scan and P-scan modes, Flaw sizing in ultrasonic inspection: AVG, Amplitude, Transmission, TOFD, Satellite pulse, Multi- modal transducer, Zonal method using focused beam. Flow location methods, Signal processing in Ultrasonic NDT; Mimics, spurious echos and noise. Ultrasonic flaw evaluation.

#### UNIT - IV

Holography: Principles and practices of Optical holography, acoustical, microwave, x-ray and electron beam holography techniques.

#### UNIT - V

Applications: NDT in flaw analysis of Pressure vessels, piping, NDT in Castings, Welded constructions, etc., Case studies.

#### **TEXT BOOKS:**

- 1. Ultrasonic testing by Krautkramer and Krautkramer
- 2. Ultrasonic inspection 2 Training for NDT: E. A. Gingel, Prometheus Press,
- 3. ASTM Standards, Vol 3.01, Metals and alloys



II Year I Semester	QUALITY ENGINEERING (PROGRAM ELECTIVE-5)	L	P	С
	(22000201202012120)	3	0	3

#### **UNIT-I**

**QUALITY VALUE AND ENGINEERING:** An overall quality system, quality engineering in production design, quality engineering in design of production processes. Loss Function and Quality Level: Derivation and use of quadratile loss function, economic consequences of tightening tolerances as a means to improve quality, evaluations and types tolerances.(N-type,S-type and L-type)

#### **UNIT II:**

**TOLERANCE DESIGN AND TOLERANCING:** Functional limits, tolerance design for N-type. L-type and S-type characteristics, tolerance allocation for multiple components. Parameter and Tolerance Design: Introduction to parameter design, signal to noise ratios, Parameter design strategy, some of the case studies on parameter and tolerance designs.

#### UNIT – III

**DOE:** DOE process steps, Observation method, Ranking method, Column effects method and Plotting method.

**ANALYSIS OF VARIANCE (ANOVA):** Introduction to ANOVA, Need for ANOVA, NO-way ANOVA, One-way ANOVA, Two-way ANOVA, Critique of F-test, ANOVA for four level factors, multiple level factors.

#### **UNIT-IV**

**ORTHOGONAL ARRAYS:** Typical test strategies, better test strategies, efficient test strategies, steps in designing, conducting and analyzing an experiment. Interpolation of Experimental Results: Interpretation methods, percent contributor, estimating the mean.

#### UNIT - V

**SIX SIGMA AND THE TECHNICAL SYSTEM:** Six sigma DMAIC methodology, tools for process improvement, six sigma in services and small organizations, statistical foundations, statistical methodology.

#### **TEXT BOOK:**

1. Taguchi Techniques for Quality Engineering / Phillip J. Ross / McGraw Hill/ Intl. II Edition, 1995.

- Quality Engineering in Production systems by G. Taguchi, A. Elsayed et al, McGraw Hill Intl. Pub 1989
- 2. Taguchi Methods explained: Practical steps to Robust Design / Papan P. Bagchi *I* Prentice Hall Pvt. Ltd., New Delhi.



II Year I Semester	GREEN MANUFACTURING (PROGRAM ELECTIVE-5)	L	P	С
	(2 2 2 0 2 2 2 2 2 2 2 2 )	3	0	3

#### UNIT -I

**INTRODUCTION TO MANUFACTURING** Definition of manufacturing, Impact of manufacturing in environmental ecology, Role of manufacturing sector in national growth ,Technological change and evolving risk , concepts of "green" manufacturing need of green manufacturing ,Green manufacturing strategies , Green manufacturing – motivation, barriers, regulation, policy , Casting defects and remedies. , Advantages and limitations of green manufacturing .

#### UNIT II

**GREEN MANUFACTURING TOOLS** Principles of green manufacturing and its efficiency, Green manufacturing and sustainability, System model architecture and module, Design and planning, control or tools for green manufacturing (Qualitative Analysis, Consumption Analysis, Life Cycle Analysis, Efficiency, Sustainability tools) Standards for green manufacturing (ISO 14000 and OHSAS 18000, Waste stream mapping and application Identify and apply the concepts of product and process design with environmental forethought, Design for environment and for sustainability - Discuss the Product Life Cycle of manufactured goods.

#### **UNIT III**

ATTRIBUTES DECISION MAKING METHODS Introduction to Multi attributes decision making methods, definition, structure for Multi attributes decision making, Reference methods variants and analysis of different methods like Simple Additive Method (SAM) Weighted Product Method (WPM. Analytic Hierarchy Process (AHP) Technique for Order of Preference by Similarity to Ideal Solution (TOPSIS), Grey Relation Analysis (GRA Elimination and Choice Expressing Reality (ELECTRE) ViseKriterijumska Optimizacija I Kompromisno Resenje (VIKOR), Problems based on different MADMs.

#### **UNIT IV**

**CREATING LEAN AND GREEN ORGANISATION** Question wasteful practices Gain lean and green endorsement, collaboration to achieve lean and green goals Track progress for environment and profits. Creation of sustainable growth Enabling techniques for assuring green manufacturing, Drivers of green manufacturing, impact, advantages and disadvantages of drivers, Green architecture and buildings, Sustainable manufacturing resources management, Carbon footprint analysis and management of manufacturing processes, Green Process Economics, Resource Recovery and Reuse.



#### **UNIT V**

CASE STUDIES IN GREEN MANUFACTURING Design resources saving into product and processes, Closed loop & Open Loop production system, Green manufacturing through clean energy supply, semiconductors manufacturing, Various case studies of implementation of semiconductors manufacturing at industries, Green packaging and supply chain, Various case studies of implementation of Optimizing Logistics solution at industries, Environmental implication of Nano manufacturing, Various case studies of implementation of lean manufacturing at industries Various case studies of implementation of Optimizing process or product at industries.

#### **TEXT BOOKS:**

- 1. Ronald G. Askin& Jeffrey B. Goldberg, "Design and Analysis of Lean Production Systems", John Wiley & Sons, 2003.
- 2. Rao.P.N, "Manufacturing Technology, Vol I and II", Tata McGraw Hill PublishingCo., 3rd edition, Sixth Reprint 2010

#### REFERENCE BOOKS/OTHER READING MATERIAL

- 1. Charles Wankel "21st century management: a reference handbook" SAGE Publications, Inc., 2008.
- 2. Christian N. Madu "Handbook of environmentally conscious manufacturing" London: Kluwer Academic Publishers, 2001.
- 3. T.E. Graedel& B.R. Allenby "Industrial Ecology" Pearson Education, Inc. 2003.
- 4. Joseph Sarkis "Greener manufacturing and operations: from design to delivery and back" Greenleaf Pub., 2001.
- 5. Ranky, P.G.: "An Introduction to Alternative Energy Sources: An interactive multimedia 3D eBook publication by CIMware USA, Inc. and CIMware Ltd., UK, ISBN 1-872631- 97-5, 2008.



II Year I Semester	MOOCS/NPTEL (PROGRAM ELECTIVE-5)	L	P	С
	(2210 021111 222 022 (20)	3	0	3



		L	P	C
II Year I Semester	NANO TECHNOLOGY	_	_	_
	(OPEN ELECTIVE )	3	0	3

#### **UNIT-I**

Introduction, Size and shape dependence of material properties at the nanoscale, scaling relations, can nanorobots walk and nanoplanes fly, Nano scale elements in conventional technologies, Mechanics at nanoscale Enhancement of mechanical properties with decreasing size, Nanoelectromechanical systems, nano machines, Nano fluidics, filtration, sorting, Molecular motors, Application of Nano Technology.

#### **UNIT-II**

Nano material Synthesis Techniques: Top-down and bottom-up nanofabrication, Synthesis of nano composites, The Intel-IBM approach to nanotechnology: lithography, etching, ion implantation, thin film deposition, nano coatings and nano indentation, Electron beam lithography, Soft lithography: nanoimprinting and microcontact printing, Solution/plasma-phase nanofabrication, sol-gel methods, template techniques.

#### **UNIT-III**

Imaging/characterization of nanostructures General considerations for imaging, Scanning probe techniques: XRD, SEM, TEM, AFM and NSOM.

#### **UNIT-IV**

Metal and semiconductor nanoparticles Synthesis, stability, control of size, Optical and electronic properties, Ultra-sensitive imaging and detection with nano particles, bioengineering applications, Catalysis. Semiconductor and metal nanowires Vapor/liquid/solid growth and other synthesis techniques, Nanowire transistors and sensors.

#### **UNIT-V**

#### Carbon nanotubes

Structure and synthesis, Electronic, vibrational, and mechanical properties, How can C nanotubes enable faster computers, brighter TV screens, and stronger mechanical reinforcement?

#### **TEXT BOOKS:**

- 1. Nanoscale Science and Technology by Kelsall, Hamley, and Geoghegan, Wiley (2005)
- 2. Introduction to Nanoscale Science and Technology by Di Ventra, Evoy, and Heflin, Kluwer Academic Publishers (2004).

- 1. Introduction to Nanotechnology by Poole and Owens, Wiley (2003)
- 2. Nanochemistry: A Chemical Approach to Nanomaterials, Ozin and Arsenault, RSC Publishing (2006).



II Year I Semester	OPTIMIZATION TECHNIQUES	L	P	C
	(OPEN ELECTIVE)	3	0	3

#### UNIT - I

**CLASSICAL OPTIMIZATION TECHNIQUES:** Single variable optimization with and without constraints, multi – variable optimization without constraints, multi – variable optimization with constraints – method of Lagrange multipliers, Kuhn-Tucker conditions, merits and demerits of classical optimization techniques.

#### **UNIT - II**

**NUMERICAL METHODS FOR OPTIMIZATION:** Nelder Mead's Simplex search method, Gradient of a function, Steepest descent method, Newton's method, Pattern search methods, conjugate method, types of penalty methods for handling constraints, advantages of numerical methods.

#### **UNIT - III**

**GENETIC ALGORITHM (GA):** Differences and similarities between conventional and evolutionary algorithms, working principle, reproduction, crossover, mutation, termination criteria, different reproduction and crossover operators, GA for constrained optimization, draw backs of GA, **GENETIC PROGRAMMING (GP):** Principles of genetic programming, terminal sets, functional sets, differences between GA & GP, random population generation, solving differential equations using GP.

**MULTI-OBJECTIVE GA:** Pareto's analysis, Non-dominated front, multi – objective GA, Non-dominated sorted GA, convergence criterion, applications of multi-objective problems .

#### UNIT - IV

#### APPLICATIONS OF OPTIMIZATION IN DESIGN AND MANUFACTURING SYSTEMS:

Some typical applications like optimization of path synthesis of a four-bar mechanism, minimization of weight of a cantilever beam, optimization of springs and gears, general optimization model of a machining process, optimization of arc welding parameters, and general procedure in optimizing machining operations sequence.

#### **UNIT V**

**RELIABILITY:** Concepts of Engineering Statistics, risk and reliability, probabilistic approach to design, reliability theory, design for reliability, numerical problems, hazard analysis.

#### **TEXT BOOKS:**

- 1. Optimization for Engineering Design Kalyanmoy Deb, PHI Publishers
- 2. Engineering Optimization S.S.Rao, New Age Publishers
- 3. Reliability Engineering by L.S.Srinath
- 4. Multi objective genetic algorithm by Kalyanmoy Deb, PHI Publishers.



- 6. Genetic algorithms in Search, Optimization, and Machine learning D.E.Goldberg, Addison-Wesley Publishers
- 7. Multi objective Genetic algorithms Kalyanmoy Deb, PHI Publishers
- 8. Optimal design Jasbir Arora, Mc Graw Hill (International) Publishers
- 9. An Introduction to Reliability and Maintainability Engineering by CE Ebeling, Waveland Printers Inc., 2009
- 10. Reliability Theory and Practice by I Bazovsky, Dover Publications, 2013



	PRODUCT DESIGN AND	L	P	C
II Year I Semester	MANUFACTURING	2	0	2
	(OPEN ELECTIVE)	3	0	3

#### Unit-1

Engineering materials, metals and their properties, uses, processing methods, design data and applications, selection criteria.

Manufacturing and processing limitations, comparative studies; plastics and composites, types, classifications, properties, processing techniques and limitation, selection of plastics for specific applications, finishing and surface coating of different materials. processing of polymers and ceramics, surface modification of materials.

#### **Unit-II**

An overview of three stages of product design, generating and evaluating conceptual alternatives from manufacturing point of view, selection of material and processes, evaluating part configuration for manufacturability, evaluating parametric design for manufacturability.

#### **Unit-III**

Design for manufacture, influence of materials process and tooling on the design of components manufactured by metal casting, forming and joining, form design of components. Recent developments in casting, machining, forming and finishing

#### **Unit-IV**

Product design for manual assembly, product design for high- speed automatic assembly and product design for robot assembly.

#### Unit-V

Ergonomics and automated systems, expert systems for ergonomic design, anthropomorphic data and its application in ergonomic design, limitations of anthropomorphic data, use of computerized database

Aesthetic Concepts: Concepts of Unity, concept of order with variety, concept of purpose, style and environment, aesthetic expression, style – components of style, house style, Observing style in capital goods.

#### **Reference Books:**

- 1. Dieter, G.E, Engineering Design: A materials and Processing Approach, McGraw Hill, 1991
- 2. Ashby, M.F., Materials selection in mechanical design, Pergamon press, 1992
- 3. Oswaid, P.F and Begeman, M., Manufacturing Process, John Willy, 1987
- 4. Levy, S. and Dubois, L.H. Plastics production design Engineering Handbook, Methuen Inc, 1985
- 5. Product Design by Kevin otto, Kristin wood.



M.Tech – III & IV		L	T	P	C	
Sem						
	DESERTAION PHASE – I & II					

#### **Syllabus Contents:**

The dissertation / project topic should be selected / chosen to ensure the satisfaction of the urgent need to establish a direct link between education, national development and productivity and thus reduce the gap between the world of work and the world of study. The dissertation should have the following

- Relevance to social needs of society
- Relevance to value addition to existing facilities in the institute
- Relevance to industry need
- Problems of national importance
- Research and development in various domain
   The student should complete the following:
- Literature survey Problem Definition
- Motivation for study and Objectives
- Preliminary design / feasibility / modular approaches
- Implementation and Verification
- Report and presentation

The dissertation stage II is based on a report prepared by the students on dissertation allotted to them. It may be based on:

- Experimental verification / Proof of concept.
- Design, fabrication, testing of Communication System.
- The viva-voce examination will be based on the above report and work.

#### Guidelines for Dissertation Phase – I and II at M. Tech. (Electronics):

- As per the AICTE directives, the dissertation is a yearlong activity, to be carried out and evaluated in two phases i.e. Phase I: July to December and Phase II: January to June.
- The dissertation may be carried out preferably in-house i.e. department's laboratories and centers OR in industry allotted through department's T & P coordinator.
- After multiple interactions with guide and based on comprehensive literature survey, the student shall identify the domain and define dissertation objectives. The referred literature should preferably include IEEE/IET/IETE/Springer/Science Direct/ACM journals in the areas of Computing and Processing (Hardware and Software), Circuits-Devices and Systems, Communication-Networking and Security, Robotics and Control Systems, Signal Processing and Analysis and any other related domain. In case of Industry sponsored projects, the relevant application notes, while papers, product catalogues should be referred and reported.
- Student is expected to detail out specifications, methodology, resources required, critical issues involved in design and implementation and phase wise work distribution, and submit the proposal within a month from the date of registration.



- Phase I deliverables: A document report comprising of summary of literature survey, detailed objectives, project specifications, paper and/or computer aided design, proof of concept/functionality, part results, A record of continuous progress.
- Phase I evaluation: A committee comprising of guides of respective specialization shall assess the progress/performance of the student based on report, presentation and Q &A. In case of unsatisfactory performance, committee may recommend repeating the Phase-I work.
- During phase II, student is expected to exert on design, development and testing of the
  proposed work as per the schedule. Accomplished results/contributions/innovations should
  be published in terms of research papers in reputed journals and reviewed focused
  conferences OR IP/Patents.
- Phase II deliverables: A dissertation report as per the specified format, developed system in the form of hardware and/or software, a record of continuous progress.
- Phase II evaluation: Guide along with appointed external examiner shall assess the
  progress/performance of the student based on report, presentation and Q &A. In case of
  unsatisfactory performance, committee may recommend for extension or repeating the work
  Course Outcomes:

At the end of this course, students will be able to

- 1. Ability to synthesize knowledge and skills previously gained and applied to an in-depth study and execution of new technical problem.
- 2. Capable to select from different methodologies, methods and forms of analysis to produce a suitable research design, and justify their design.
- 3. Ability to present the findings of their technical solution in a written report.
- 4. Presenting the work in International/ National conference or reputed journals.